



HAYNES BEFFEL & WOLFELD LLP

MAR 25 2002

COPIES OF PAPERS
ORIGINALLY FILED

Page 1 of 1

RECEIVED
UNITED STATES PATENT AND TRADEMARK OFFICECOMMISSIONER FOR PATENTS
UNITED STATES PATENT AND TRADEMARK OFFICE
WASHINGTON, D.C. 20231
www.uspto.gov

APPLICATION NUMBER	FILING/RECEIPT DATE	FIRST NAMED APPLICANT	ATTORNEY DOCKET NUMBER
10/084,787	02/25/2002	Rajendra Pendse	CPAC 1010-2 US

22470
HAYNES BEFFEL & WOLFELD LLP
P O BOX 366
HALF MOON BAY, CA 94019

CONFIRMATION NO. 6217
FORMALITIES LETTER

OC00000007681121

Date Mailed: 03/20/2002

NOTICE TO FILE MISSING PARTS OF NONPROVISIONAL APPLICATION

FILED UNDER 37 CFR 1.53(b)

Filing Date Granted

An application number and filing date have been accorded to this application. The item(s) indicated below, however, are missing. Applicant is given **TWO MONTHS** from the date of this Notice within which to file all required items and pay any fees required below to avoid abandonment. Extensions of time may be obtained by filing a petition accompanied by the extension fee under the provisions of 37 CFR 1.136(a).

- The oath or declaration is missing.
A properly signed oath or declaration in compliance with 37 CFR 1.63, identifying the application by the above Application Number and Filing Date, is required.
- To avoid abandonment, a late filing fee or oath or declaration surcharge as set forth in 37 CFR 1.16(l) of \$130 for a non-small entity, must be submitted with the missing items identified in this letter.
- **The balance due by applicant is \$ 130.**

*A copy of this notice **MUST** be returned with the reply.**Jayale A-*

Customer Service Center

Initial Patent Examination Division (703) 308-1202

PART 2 - COPY TO BE RETURNED WITH RESPONSE

05/13/2002 STEUMEL 00000040 10084787

01 FC:105

130.00 OP

T.D.
MP

Certificate of Mailing

I hereby certify that this correspondence is being deposited with the U.S. Patent and Trademark Office with sufficient postage as first class mail in an envelope addressed to:
Commissioner of Patents, Washington, D.C., 20231, on May 1, 2002.

Jinda Shaw

Date

May 1, 2002

COPY OF PAPERS
ORIGINALLY FILED



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of)
Rajendra PENDSE *et al.*)
Application No.: 10/084,787) Examiner: Unknown
Filed: February 25, 2002) Group Art Unit: 2811
Title: Super-thin high speed flip) Date: May 1, 2002
chip package)
)
)
)

TRANSMITTAL LETTER FOR MISSING PARTS OF APPLICATION

BOX MISSING PARTS
Commissioner of Patents
Washington, D.C. 20231

Sir:

In response to the Notice to File Missing Parts of Nonprovisional Application dated March 20, 2002, enclosed please find:

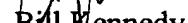
- Copy of the Notice to File Missing Parts of Nonprovisional Application – Filing Date Granted;
- Combined Declaration and Power of Attorney for Utility Patent Application with surcharge as set forth in 37 CFR 1.16(l) (\$130.00);
- Check number 1753 in the amount of \$130.00 covering fees due;
- Separate Letter to Official Draftsperson with one (1) sheet(s) of formal drawings;
- Copy of the executed Assignment and Form PTO-1595 filed May 1, 2002.

Attorney Docket No.: CPAC 1010-2 US
USSN 10/084,787

PATENT

The Commissioner is hereby authorized to charge any additional fees that may be required by this paper, and to credit any overpayment, to Deposit Account No. 50-0869 (Docket No. CPAC 1010-2 US). A duplicate of this paper is enclosed.

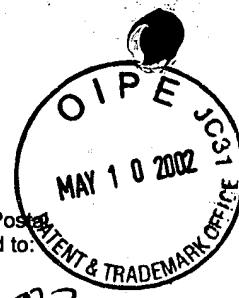
Respectfully submitted,


Bill Kennedy
Registration No. 33,407

Date: May 1, 2002

HAYNES BEFFEL & WOLFELD LLP
P.O. Box 366
Half Moon Bay, CA 94019
(650) 712-0340

Attorney Docket No.: CPAC 1010-2 US
USSN 10/084,787



PATENT

COPY OF PAPERS
ORIGINALLY FILED

Certificate of Mailing

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as first class mail in an envelope addressed to:
Commissioner of Patents, Washington, D.C., 20231, on May 1, 2002.

Linda Shaw
Linda Shaw

May 1, 2002
Date

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of)
Rajendra PENDSE *et al.*)
Application No.: 10/084,787) Examiner: Unknown
Filed: February 25, 2002) Group Art Unit: 2811
Title: Super-thin high speed flip) Date: May 1, 2002
chip package)
)

SEPARATE LETTER TO OFFICIAL DRAFTSPERSON

Official Draftsperson
Box Missing Parts
Commissioner Of Patents
Washington, D.C. 20231

Official Draftsperson:

In connection with the above-referenced U. S. patent application, transmitted herewith are the following papers:

One (1) sheet of formal drawing(s) (Figs 1, 2, 3 and 4).

Authorization is hereby given to deduct from or credit to Deposit Account No. 50-0869 (CPAC 1010-2 US), any additional fees that may be required with this matter.

R. Kennedy Respectfully submitted,

B. Kennedy Reg. No. 33,407
Bill Kennedy
Registration No. 33,407

Date: May 1, 2002
Haynes Beffel & Wolfeld LLP
P.O. Box 366
Half Moon Bay, CA 94019
(650) 712-0340